

AD6C311

1 Form A 400V / 10 Ω MOSFET Output Solid State Relay







## Description

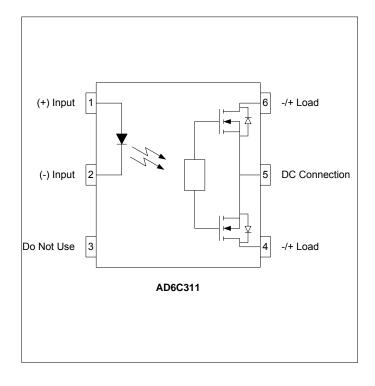
The AD6C311 is a bi-directional, single-pole, single-throw, normally open multipurpose solid state relay. It is designed to replace electromechanical relays in general purpose switching applications. The relay consists of an integrated circuit that drives two rugged source-to-source enhancement type DMOS transistors - optically coupled to a light emitting diode.

The AD6C311 comes standard in a miniature 6 pin DIP package making it ideal for high-density board applications.

## **Applications**

- Meter Reading Systems
- Multiplexers
- **Data Acquisition**
- Medical Equipment
- **Battery Monitoring**
- Home / Safety Security Systems

## **Schematic Diagram**



#### **Features**

- Low Input Control Current (2.5mA TYP)
- 200mA Maximum Continuous Load Current
- Low On Resistance ( $10\Omega$  TYP)
- High Isolation Voltage (3.75kV<sub>RMS</sub>, 5kV<sub>RMS</sub> -H Option)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

## **Agency Approvals**

UL/C-UL: File # E201932

VDE: File # 40035191 (EN 60747-5-2)

## Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

| Storage Temperature                    | 55 to +125°C |
|--|--------------|
| Operating Temperature                  | 40 to +85°C  |
| Continuous Input Current               | 50mA         |
| Transient Input Current                |              |
| Reverse Input Control Voltage          | 6V           |
| Input Power Dissipation                |              |
| Output Power Dissipation               |              |
| Solder Temperature – Wave (10sec)      |              |
| Solder Temperature – IR Reflow (10sec) | 260°C        |

#### **Ordering Information**

| Part | Num | ber | D | escr | iptio | n |
|------|-----|-----|---|------|-------|---|
|------|-----|-----|---|------|-------|---|

6 pin DIP, (50/Tube) AD6C311

5kV<sub>RMS</sub> Viso, 6 pin DIP, (50/Tube) AD6C311-H AD6C311-S 6 pin SMD, (50/Tube) 5kV<sub>RMS</sub>, 6 pin SMD, (50/Tube) AD6C311-HS

AD6C311-STR 6 pin SMD, Tape and Reel (1000/Reel) AD6C311-HSTR 5kV<sub>RMS</sub>, 6 pin SMD, Tape and Reel (1000/Reel)

NOTE: Suffixes listed above are not included in marking on device for part number identification



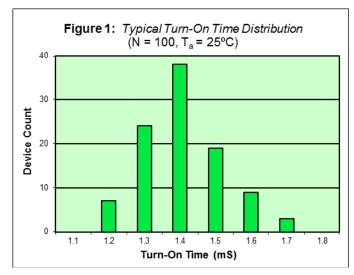
**Electrical Characteristics,** T<sub>A</sub> = 25°C (unless otherwise specified)

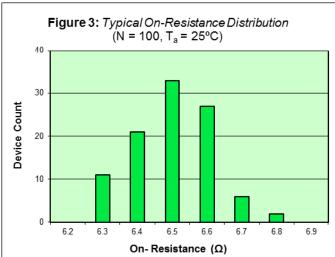
| Parameter                | Symbol               | Min.  | Тур.             | Max. | Units            | Test Conditions                            |  |  |
|--------------------------|----------------------|-------|------------------|------|------------------|--|--|--|
| Input Specifications     |                      |       |                  |      |                  |  |  |  |
| LED Forward Voltage      | V <sub>F</sub>       | -     | 1.2              | 1.5  | V                | I <sub>F</sub> = 10mA                      |  |  |
| LED Reverse Voltage      | $BV_R$               | 6     | -                | -    | V                | I <sub>R</sub> = 10μA                      |  |  |
| Turn-On Current          | I <sub>F</sub>       | -     | 2.5              | 5    | mA               | I <sub>O</sub> = 200mA                     |  |  |
| Turn-Off Current         | I <sub>FOFF</sub>    | -     | 1                | -    | mA               | -  |  |  |
| Output Specifications    |                      |       |                  |      |                  |  |  |  |
| Blocking Voltage         | V <sub>B</sub>       | 400   | -                | -    | V                | Ι <sub>0</sub> =1μΑ                        |  |  |
| Continuous Load Current  | Io                   | -     | -                | 200  | mA               | I <sub>F</sub> =5mA                        |  |  |
| On Resistance            | R <sub>on</sub>      | -     | 6.5              | 10   | Ω                | I <sub>F</sub> =5mA, I <sub>O</sub> =200mA |  |  |
| Leakage Current          | I <sub>Oleak</sub>   | -     | 0.05             | 1    | μА               | I <sub>F</sub> =0mA, V <sub>O</sub> =400V  |  |  |
| Output Capacitance       | C <sub>OUT</sub>     | -     | 25               | 50   | pF               | I <sub>F</sub> =0mA, f=1.0MHz              |  |  |
| Offset Voltage           | V <sub>OFFSET</sub>  | -     | -                | 0.2  | mV               | I <sub>F</sub> =5mA                        |  |  |
| Coupled Specifications   |                      |       |                  |      |                  |  |  |  |
| Turn-On Time             | T <sub>ON</sub>      | -     | 1.5              | 5    | mS               | I <sub>F</sub> =5mA, I <sub>O</sub> =200mA |  |  |
| Turn-Off Time            | T <sub>OFF</sub>     | -     | 0.05             | 1    | mS               | I <sub>F</sub> =0mA, I <sub>O</sub> =200mA |  |  |
| Coupled Capacitance      | C <sub>COUPLED</sub> | -     | 3                | -    | pF               |  |  |  |
| Contact Transient Ratio  | -                    | 2,000 | 7,000            | 0    | V/μS             | dV = 50V                                   |  |  |
| Isolation Specifications |                      |       |                  |      |                  |  |  |  |
| Isolation Voltage        | V <sub>ISO</sub>     | 3,750 | -                | -    | V <sub>RMS</sub> | RH ≤ 50%, t=1min                           |  |  |
| -H Option                | V <sub>ISO</sub>     | 5,000 | -                | -    | V <sub>RMS</sub> | RH ≤ 50%, t=1min                           |  |  |
| Input-Output Resistance  | R <sub>I-O</sub>     | -     | 10 <sup>12</sup> | -    | Ω                | V <sub>I-O</sub> = 500V <sub>DC</sub>      |  |  |

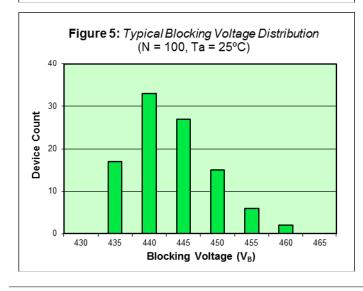


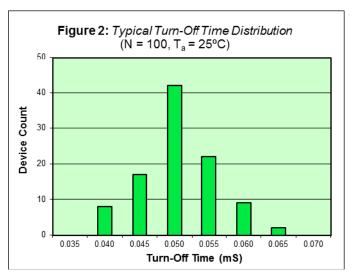


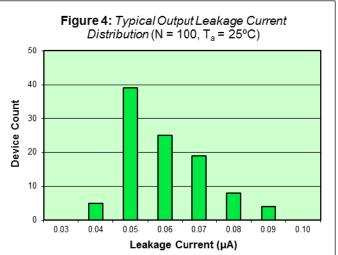
## AD6C311 Performance & Characteristics Plots, T<sub>A</sub> = 25°C (unless otherwise specified)

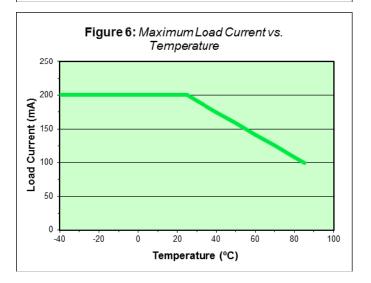












## **AD6C311 Solder Temperature Profile Recommendations**

## (1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:

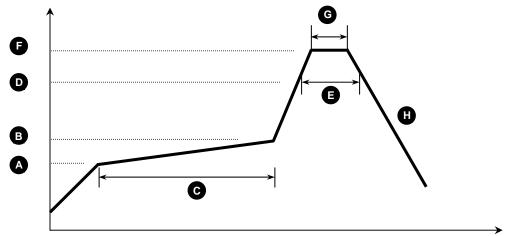


Figure 1

| Process<br>Step | Description                        | Parameter |
|-----------------|------------------------------------|-----------|
| Α               | Preheat Start Temperature (°C)     | 150°C     |
| В               | Preheat Finish Temperature (°C)    | 180°C     |
| С               | Preheat Time (s)                   | 90 - 120s |
| D               | Melting Temperature (°C)           | 230°C     |
| E               | Time above Melting Temperature (s) | 30s       |
| F               | Peak Temperature, at Terminal (°C) | 260°C     |
| G               | Dwell Time at Peak Temperature (s) | 10s       |
| Н               | Cool-down (°C/s)                   | <6°C/s    |

## (2) Wave Solder:

Maximum Temperature: 260°C (at terminal)

Maximum Time: 10s

Pre-heating: 100 - 150°C (30 - 90s)

Single Occurrence

## (3) Hand Solder:

Maximum Temperature: 350°C (at tip of soldering iron)

Maximum Time:

Single Occurrence

350°C (at tip of soldering in 3s



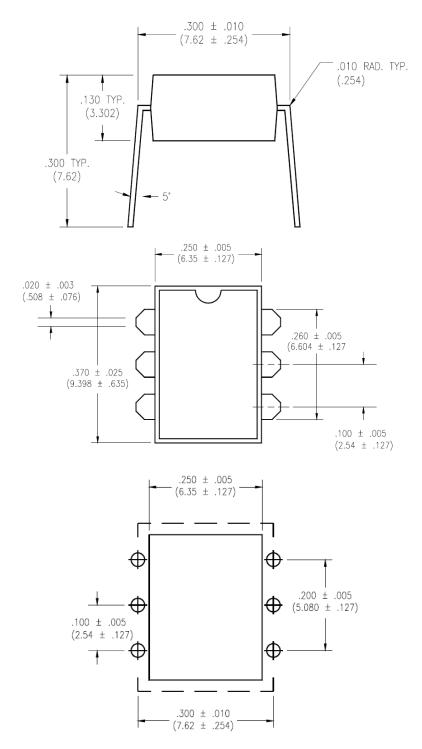
MOSFET Output Solid State Relay

## **AD6C311 Package Dimensions**

6 PIN DIP Package

Note: All dimensions in inches ["] with millimeters in parenthesis ()

Device Weight: 0.45g



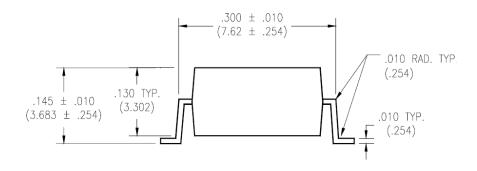


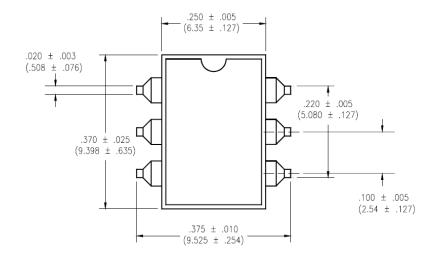
## **AD6C311 Package Dimensions**

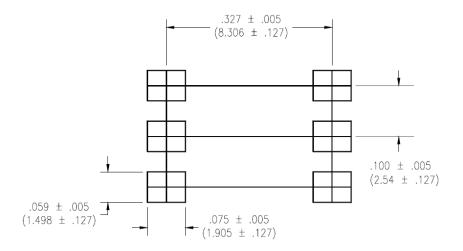
## 6 PIN SMD Surface Mount Package (-S)

**Note:** All dimensions in inches ["] with millimeters in parenthesis ()

Device Weight: 0.45g







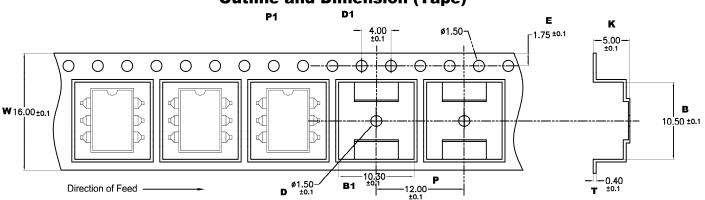
**Note:** All dimensions in millimeters



## **AD6C311 Package Dimensions**

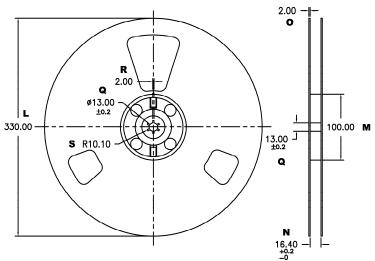
6 PIN SMD Tape & Reel (-STR)

# Outline and Dimension (Tape)



| W          | В          | B1         | P          | P1        | K         | E         | Т         | D         | D1        |
|------------|------------|------------|------------|-----------|-----------|-----------|-----------|-----------|-----------|
| 16.00 ±0.1 | 10.50 ±0.1 | 10.30 ±0.1 | 12.00 ±0.1 | 4.00 ±0.1 | 5.00 ±0.1 | 1.75 ±0.1 | 0.40 ±0.1 | 1.50 ±0.1 | 1.50 ±0.1 |

# **Outline and Dimensions (Reel)**

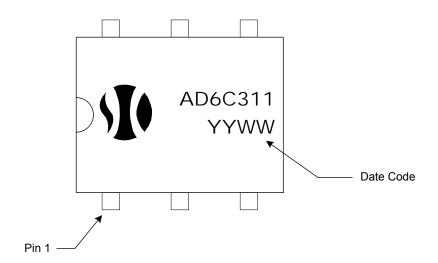


Packaging: 1,000 pcs / reel

| L      | М      | N          | 0         | Q          | R    | S     |
|--------|--------|------------|-----------|------------|------|-------|
| 330.00 | 100.00 | 16.40 +0.2 | 2.00 ±0.1 | 13.00 ±0.2 | 2.00 | 10.00 |



## AD6C311 Package Marking



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